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**DOCKET NO.: 217555US0** 

## IN THE UNITED STATES PATENT & TRADEMARK OFFICE

IN RE APPLICATION OF

MASAYUKI IKENO, ET AL.

: EXAMINER: ROBERTSON, J.

SERIAL NO: 10.020,219

FILED: DECEMBER 18, 2001

: GROUP ART UNIT: 1712

FOR:

ORGANOPOLYSILOXANE

COMPOSITION FOR MOLDING

## <u>AMENDMENT</u>

ASSISTANT COMMISSIONER FOR PATENTS WASHINGTON, D.C. 20231

SIR:

Responsive to the Official Action of January 31, 2003, please amend the aboveidentified application as follows:

## IN THE CLAIMS

Please cancel Claim 4.

Please amend Claim 1 as in the attached marked-up copy to read as follows:

- 1. (Amended) An organopolysiloxane composition for molding purposes comprising:
- (A) an organopolysiloxane with at least two alkenyl groups bonded to silicon atoms within a single molecule, having a viscosity at 25°C of 0.05 to 100 Pa·s,
- (B) a straight chain organopolysiloxane with a hydrogen atom bonded to a silicon atom at both terminals and with no aliphatic unsaturated bonds within a molecule represented